### **Overview**

### HP ProBook 445 G8 Notebook PC



#### Left

- 1. Internal Microphones (2)
- 2. Webcam LED (Optional)
- 3. HD and IR Camera (Optional)
- 4. Camera Shutter (Only available with webcam)
- 5. IR Camera LED (Optional)

- 6. Clickpad
- 7. SuperSpeed USB Type-A 5 Gbps signaling rate Power Port
- 8. Ethernet Port (RJ-45)
- 9. Nano Security Lock Slot (Lock sold separately)

### **Overview**



#### Right

- 1. Power Connector
- 2. SuperSpeed USB Type-C<sup>®</sup> 10Gbps signaling rate (USB Power Delivery, DisplayPort™ 1.4) (Select models)
- **3.** SuperSpeed USB Type-A 5 Gbps signaling rate Charging Port
- **4.** SuperSpeed USB Type-A 5 Gbps signaling rate Port
- 5. HDMI 1.4b Port (Cable not included)

- 6. Audio Combo Jack
- 7. Micro SD Card Reader (Select Models)
- 8. Touch Fingerprint Sensor (Select Models)

#### Overview

#### **AT A GLANCE**

- Windows 11 Pro, other Windows OS, or FreeDOS preinstalled
- A new compact design with lift-anywhere edge and configurable all metal chassis
- Choice of AMD Cezanne™ 5000 series mobile processors, R3, R5, R5 Pro, R7and R7 Pro
- Integrated AMD Radeon™ Vega graphics
- Fast and upgradeable dual channel DDR4 SODIMM memory up to 32 GB
- Choice of 35.56 cm (14.0") diagonal HD, Ultra Wide Viewing Angle FHD, and Privacy Panel option
- Features redesigned quiet and responsive HP Keyboard with the HP Programmable key and backlit options
- Choice of Solid State Drives up to 1 TB
- Multi-layered security with HP SureStart Gen6, HP Privacy Camera, HP Sure View Gen3, HP Sure Sense, HP Sure Click, and optional Touch Fingerprint sensor
- Supports wireless options for connectivity on the go including gigabit-speed Wi-Fi® 6
- Supports fast charging (50% in 30 minutes) with no impact on battery recharge cycles
- Designed to support optional HP docking options including the HP Universal Dock G5
- Undergoes MIL-STD 810H tests <sup>1</sup>
- Battery Life up to 15 hours and 45 minutes

1. MIL-STD 810H is not intended to demonstrate fitness of U.S. Department of Defense contract requirements or for military use. Test results are not a guarantee of future performance under these test conditions. Accidental damage requires an optional HP Accidental Damage Protection Care Pack.

NOTE: See important legal disclosures for all listed specs in their respective features sections.



### **Technical Specifications**

#### **PRODUCT NAME**

HP ProBook 445 G8 Notebook PC

#### **OPERATING SYSTEM**

Preinstalled Windows 11 Pro <sup>2</sup>

Windows 11 Pro Education 2

Windows 11 Home - HP recommends Windows 11 Pro for business 2

Windows 11 Home Single Language – HP recommends Windows 11 Pro for business <sup>2</sup> Windows 11 Pro (Windows 11 Enterprise available with a Volume Licensing Agreement) <sup>2</sup>

Windows 10 Pro 1,2

Windows 10 Pro Education 1,2

Windows 10 Home – HP recommends Windows 11 Pro for business 1,2

Windows 10 Home Single Language – HP recommends Windows 11 Pro for business <sup>1,2</sup> Windows 10 Pro (Windows 10 Enterprise available with a Volume Licensing Agreement) <sup>1,2</sup>

**FreeDOS** 

- 1. Device comes with Windows 10 and a free Windows 11 upgrade or may be preloaded with Windows 11. Upgrade timing may vary by device. Features and app availability may vary by region. Certain features require specific hardware (see Windows 11 Specifications).
- 2. Not all features are available in all editions or versions of Windows. Systems may require upgraded and/or separately purchased hardware, drivers, software or BIOS update to take full advantage of Windows functionality. Windows is automatically updated and enabled. High speed internet and Microsoft account required. ISP fees may apply and additional requirements may apply over time for updates. See <a href="http://www.windows.com">http://www.windows.com</a>.

**NOTE**: HP tested Windows 10, version 1909 on this platform. For testing information on newer versions of Windows 10, please see https://support.hp.com/document/c05195282.



### **Technical Specifications**

#### **PROCESSORS**

AMD Ryzen™ 3 5400U APU with AMD Radeon™ Graphics (2.6 GHz base clock, up to 4.0 GHz max boost clock, 8 MB L3 cache. 4 cores)<sup>3,4,5,6</sup>

AMD Ryzen™ 5 5600U APU with AMD Radeon™ Graphics (2.3 GHz base clock, up to 4.2 GHz max boost clock, 16MB L3 cache, 6 cores)<sup>3,4,5,6</sup>

AMD Ryzen™ 7 5800U APU with AMD Radeon™ Graphics (1.9 GHz base clock, up to 4.4 GHz max boost clock, 16 MB L3 cache, 8 cores)<sup>3,4,5,6</sup>

AMD Ryzen™ 5 PRO 5650U APU with Radeon™ Graphics (2.3 GHz base clock, up to 4.2 GHz max boost clock, 16 MB L3 cache, 6cores) <sup>3,4,5,6</sup>

AMD Ryzen™ 7 PRO 5850U APU with Radeon™ Graphics (1.9 GHz base clock, up to 4.4 GHz max boost clock, 16 MB L3 cache, 8cores) <sup>3,4,5,6</sup>

#### **Processor Family**

AMD Cezanne™ 5000 Series Mobile Processors 6

- 3. Processor speed denotes maximum performance mode; processors will run at lower speeds in battery optimization mode.
- 4. Multicore is designed to improve performance of certain software products. Not all customers or software applications will necessarily benefit from use of this technology. Performance and clock frequency will vary depending on application workload and your hardware and software configurations. AMD's numbering is not a measurement of clock speed.
- 5. AMD Max Burst frequency performance varies depending on hardware, software and overall system configuration.
- 6. In accordance with Microsoft's support policy, HP does not support the Windows 8 or Windows 7 operating system on products configured with Intel and AMD 7th generation and forward processors or provide any Windows 8 or Windows 7 drivers on http://www.support.hp.com.

#### **GRAPHICS**

#### Integrated

AMD Radeon™ Graphics

#### Supports

Support HD decode, DX12, HDMI 1.4 7

7. HDMI cable sold separately.

#### **DISPLAY**

#### Non-Touch

35.6 cm (14") diagonal HD SVA eDP anti-glare, narrow bezel bent, 250 nits, 45% NTSC (1366 x 768) 9.10

35.6 cm (14") diagonal HD SVA eDP anti-glare, narrow bezel bent, 250 nits, 45% NTSC for HD camera (1366 x 768) 9.10

35.6 cm (14") diagonal HD SVA eDP anti-glare, narrow bezel bent, 250 nits, 45% NTSC for HD+IR camera (1366 x 768) 9,10

35.6 cm (14") diagonal FHD UWVA eDP+PSR anti-glare, low power narrow bezel bent, 400 nits, 100% sRGB for HD camera (1920 x 1080) <sup>9,10</sup>

35.6 cm (14") diagonal FHD UWVA eDP+PSR anti-glare, low power narrow bezel bent, 400 nits, 100% sRGB for HD+IR camera (1920 x 1080) 9,10

35.6 cm (14") diagonal FHD UWVA eDP anti-glare, narrow bezel bent, 250 nits, 45% NTSC (1920 x 1080) 9,10

35.6 cm (14") diagonal FHD UWVA eDP anti-glare, narrow bezel bent, 250 nits, 45% NTSC for HD camera (1920 x 1080) 9,10

35.6 cm (14") diagonal FHD UWVA eDP anti-glare, narrow bezel bent, 250 nits, 45% NTSC for HD + IR camera



### **Technical Specifications**

(1920 x 1080) 9,10

35.6 cm (14") diagonal FHD UWVA eDP+PSR anti-glare, narrow bezel bent with HP Sure View Gen3 Integrated Privacy Screen, 1000 nits, 100% sRGB for HD camera (1920 x 1080) 9,10,11,12

35.6 cm (14") diagonal FHD UWVA eDP+PSR anti-glare, narrow bezel bent with HP Sure View Gen3 Integrated Privacy Screen, 1000 nits, 100% sRGB for HD+IR camera (1920 x 1080) 9,10,11,12

#### **HDMI8**

Supports resolution up to 4K 30Hz

- 8. HDMI cable not included.
- 9. FHD/HD content required to view FHD/HD images.
- 10. Resolutions are dependent upon monitor capability, and resolution and color depth settings.
- 11. Actual brightness will be lower with touchscreen or Sure View.
- 12. HP Sure View integrated privacy screen is an optional feature that must be configured at purchase and is designed to function in landscape orientation.

#### STORAGE AND DRIVES

#### Primary M.2 Storage

128 GB PCIe® NVMe<sup>™</sup> M.2 TLC Solid State Drive <sup>13</sup>
256 GB PCIe® NVMe<sup>™</sup> M.2 Value Solid State Drive <sup>13</sup>
512 GB PCIe® NVMe<sup>™</sup> M.2 Value Solid State Drive <sup>13</sup>
1 TB PCIe® NVMe<sup>™</sup> M.2 TLC Solid State Drive <sup>13</sup>

13. For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 30 GB (for Windows 10) is reserved for system recovery software.

#### **MEMORY**

#### **Maximum Memory**

32 GB DDR4-3200 SDRAM 14

#### Memory

32 GB DDR4-3200 SDRAM (2 x 16 GB) <sup>14</sup>
16 GB DDR4-3200 SDRAM (1 x 16 GB) <sup>14</sup>
12 GB DDR4- 3200 SDRAM (1 x 4 GB + 1 x 8 GB) <sup>14</sup>
8 GB DDR4-3200 SDRAM (1 x 8 GB) <sup>14</sup>
8 GB DDR4-3200 SDRAM (2 x 4 GB) <sup>14</sup>
4 GB DDR4-3200 SDRAM (1 x 4 GB) <sup>14</sup>

#### **Memory Slots**

2 SODIMM

Both slots are accessible/upgradeable by IT or self-maintainers only DDR4 PC4 SODIMMS, system runs at 3200 Supports Dual Channel Memory



### **Technical Specifications**

14. Due to the non-industry standard nature of some third-party memory modules, we recommend HP branded memory to ensure compatibility. If you mix memory speeds, the system will perform at the lower memory speed.

#### **NETWORKING/COMMUNICATIONS**

#### **WLAN**

Realtek RTL8822CE 802.11ac (2x2) and Bluetooth® 5 Combo  $^{15}$  Intel® Dual Band Wireless-AC 9260 802.11a/b/g/n/ac (2x2) Wi-Fi ®and Bluetooth® 5 Combo, non-vPro®  $^{15}$  Intel® AX200 Wi-Fi 6 (2x2) and Bluetooth® 5 Combo, non-vPro®  $^{45}$  Qualcomm WCN6856 Wi-Fi 6E (2x2) and Bluetooth® 5.2 combo  $^{15, 16}$  Mediatek MT7921 Wi-Fi CERTIFIED  $6^{\text{TM}}$  (2x2) and Bluetooth® 5.2 combo  $^{15, 45}$ 

#### Ethernet

Realtek 10/100/1000 GbE NIC 17

15. Wireless access point and internet service required and sold separately. Availability of public wireless access points limited. Wi-Fi 5 (802.11 ac) is backwards compatible with prior 802.11 specs.

16. Wi-Fi 6E requires a Wi-Fi 6E router, sold separately, to function in the 6GHz band. Availability of public wireless access points limited. Wi-Fi 6E is backwards compatible with prior 802.11 specs. And available in countries where Wi-Fi 6E is supported

17. The term "10/100/1000" or "Gigabit" Ethernet indicates compatibility with IEEE standard 802.3ab for Gigabit Ethernet, and does not connote actual operating speed of 1 Gb/s. For high-speed transmission, connection to a Gigabit Ethernet server and network infrastructure is required.

45. Wi-Fi 6 is designed to support gigabit data rate when transferring files between two devices connected to the same router. Requires a wireless router, sold separately, that supports 80MHz and higher channels.

#### **AUDIO/MULTIMEDIA**

#### **Audio**

2 Integrated stereo speakers Integrated microphone (Dual Array)

#### **Speaker Power**

2W/4ohm per speaker

#### Camera

720p HD camera <sup>9</sup>
720p HD camera+IR Camera <sup>9,18</sup>

9.FHD/HD content required to view FHD/HD images.

18. Sold separately or as an optional feature.



### **Technical Specifications**

#### **KEYBOARDS/POINTING DEVICES/BUTTONS & FUNCTION KEYS**

#### Keyboard

HP Premium Keyboard, spill resistant and optional Durakeys and backlit

#### **Pointing Device**

Clickpad with multi-touch gesture support

#### **Function Keys**

- F1 Display Switching
- F2 Blank or SureView On / Off
- F3 Brightness Down
- F4 Brightness Up
- F5 Audio Mute
- F6 Volume Down
- F7 Volume Up
- F8 Mic Mute
- F9 Blank or Backlit Toggle
- F10 Insert
- F11 Airplane Mode
- F12 Programmable key
- **Print Screen**

Power Button (with LED)

#### **Hidden Function Keys**

- Fn+R Break
- Fn+S Sys Rq
- Fn+C Scroll Lock



### **Technical Specifications**

#### **SOFTWARE AND SECURITY**

#### BIOS

HP BIOSphere Gen5 19

**HP Drive Lock & Automatic Drive Lock** 

**BIOS Update via Network** 

HP Secure Erase 20

Absolute Persistence Module 21

**HP LAN-Wireless Protection** 

USB enable/disable (via BIOS)

#### Software

HP Connection Optimizer 22

**HP Hotkey Support** 

myHP

HP Support Assistant<sup>23</sup>

HP QuickDrop<sup>24</sup>

**HP PC Hardware Diagnostics Windows** 

**HP Noise Cancellation Software** 

**Touchpoint Customizer for Commercial** 

**HP Notifications** 

**HP Privacy Settings** 

**HP Wireless Button Driver** 

**HP Power Manager** 

Buy Microsoft Office (Sold separately)

Microsoft Defender 25

Xerox® DocuShare® 30 day free trial offer43

HP Smart Support 44

#### **Manageability Features**

HP Driver Packs (download) 26

HP Manageability Integration Kit Gen4 (download) 27

**HP Client Catalog (download)** 

HP Client Management Script Library (download)

**HP Image Assistant (download)** 

Ivanti Management Suite (download)

#### **Security Management**

HP Pro Security Edition (Select models)28

HP Fingerprint Sensor (Select models) 29

HP Sure Click 30

HP Sure Sense 31

HP Sure Admin 32

HP Wolf Pro Security Edition<sup>33</sup>

TPM 2.0 Embedded Security Chip (Common Criteria EAL4+ Certified) (FIPS 140-2 Level 2 Certified)



### **Technical Specifications**

- 19. HP BIOSphere Gen6 requires Windows 10 and is available on select HP Pro and Elite PCs. Features may vary depending on the platform and configurations
- 20. HP Secure Erase For the methods outlined in the National Institute of Standards and Technology Special Publication 800-88 "Clear" sanitation method. HP Secure Erase does not support platforms with Intel® Optane™.
- 21. Absolute firmware module is shipped turned off and can only be activated with the purchase a license subscription and full activation of the software agent. License subscriptions can be purchased for terms ranging multiple years. Service is limited, check with Absolute for availability outside the U.S. Certain conditions apply. For full details visit:

https://www.absolute.com/about/legal/agreements/absolute/

- 22. HP Connection Optimizer requires Windows 10.
- 23. HP Support Assistant requires Windows and Internet access.
- 24. HP Quick Drop requires Internet access and Windows 10 PC preinstalled with HP QuickDrop app and either an Android device (phone or tablet) running Android 7 or higher with the Android HP QuickDrop app, and /or an iOS device (phone or tablet) running iOS 12 or higher with the iOS HP QuickDrop app.
- 25. Microsoft Defender Opt in and internet connection required for updates.
- 26. HP Driver Packs not preinstalled, however available for download at http://www.hp.com/go/clientmanagement.
- 27. HP Manageability Integration Kit can be downloaded from http://www.hp.com/go/clientmanagement.
- 28. HP Pro Security Edition is available preloaded on select HP PCs and includes HP Sure Click Pro and HP Sure Sense Pro. 3-year license required. The HP Pro Security Edition software is licensed under the license terms of the HP End User License Agreement (EULA) that can be found at: https://h30670.www3.hp.com/ecommerce/common/disclaimer.do#EN\_US as modified by the following: "7. Term. Unless otherwise terminated earlier pursuant to the terms contained in this EULA, the license for the HP Pro Security Edition (HP Sure Sense Pro and HP Sure Click Pro) is effective upon activation and will continue for thirty-six (36) months thereafter ("Initial Term"). At the end of the Initial Term you may either (a) purchase a renewal license for the HP Pro Security Edition from HP.com, HP Sales or an HP Channel Partner, or (b) continue using the standard versions of HP Sure Click and HP Sure Sense at no additional cost with no future software updates or HP Support." HP Pro Security Edition is optimized for the SMB environment and ships pre-configured manageability is optional. The HP Pro Security Edition supports a limited tool set that can be used by the HP Manageability Integration Kit which can be downloaded from http://www.hp.com/go/clientmanagement.
- 29. HP Fingerprint sensor is an optional feature that must be configured at purchase.
- 30. HP Sure Click requires Windows 10 Pro or Enterprise. See https://bit.ly/2PrLT6A\_SureClick for complete details.
- 31. HP Sure Sense is available on select HP PCs and is not available with Windows10 Home.
- 32. HP Sure Admin requires Windows 10, HP BIOS, HP Manageability Integration Kit from
- http://www.hp.com/go/clientmanagement and HP Sure Admin Local Access Authenticator smartphone app from the Android or Apple store.
- 33. HP Wolf Pro Security Edition (including HP Sure Click Pro and HP Sure Sense Pro) is available preloaded on select SKUs and, depending on the HP product purchased, includes a paid 1-year or 3-year license. The HP Wolf Pro Security Edition software is licensed under the license terms of the HP Wolf Security Software End-User license Agreement (EULA) that can be found at: https://support.hp.com/us-en/document/ish\_3875769-3873014-16 as that EULA is modified by the following:
- "7. Term. Unless otherwise terminated earlier pursuant to the terms contained in this EULA, the license for the HP Wolf Pro Security Edition (HP Sure Sense Pro and HP Sure Click Pro) is effective upon activation and will continue for either a twelve (12) month or thirty-six (36) month license term ("Initial Term"). At the end of the Initial Term you may either (a) purchase a renewal license for the HP Wolf Pro Security Edition from HP.com, HP Sales or an HP Channel Partner, or (b) continue using the standard versions of HP Sure Click and HP Sure Sense at no additional cost with no future software updates or HP Support.
- 43. Simply sign up and start using Xerox® DocuShare® Go. No credit card. No obligation. Data will become unavailable unless a subscription is entered before the end of the 30 day free trial period. See visit http://www.xerox.com/docusharego for details.
- 44. HP Smart Support is available to commercial customers through your HP Service Representative and HP Factory Configuration Services; or it can be downloaded at: http://www.hp.com/smart-support. HP Smart Support automatically



### **Technical Specifications**

collects the telemetry necessary upon initial boot of the product to deliver device-level configuration data and health insights.

#### **POWER**

#### **Power Supply**

HP Smart 65 W External AC power adapter <sup>34</sup> HP Smart 65 W EM External AC power adapter <sup>34</sup> HP Smart 65 W USB Type-C adapter <sup>34</sup> HP Smart 45 W External AC power adapter <sup>34</sup> HP Smart 45 W USB Type-C adapter <sup>34</sup>

#### **Power Cord**

3-wire plug - 1m <sup>34</sup> 2-wire plug - 1m <sup>34</sup>

#### **Primary Battery**

HP Long Life 3-cell, 45 Wh Polymer 35,36

#### **Battery Life**

Up to 15 hours and 45 minutes 37

#### **Battery Weight**

0.42 lb 190 g

- 34. Availability may vary by country.
- 35. Battery is internal and not replaceable by customer. Serviceable by warranty.
- 36. Actual battery Watt-hours (Wh) will vary from design capacity. Battery capacity will naturally decrease with shelf life, time, usage, environment, temperature, system configuration, loaded apps, features, power management settings and other factors.
- 37. Windows 10 MM18 battery life will vary depending on various factors including product model, configuration, loaded applications, features, use, wireless functionality, and power management settings. The maximum capacity of the battery will naturally decrease with time and usage. See www.bapco.com for additional details.



### **Technical Specifications**

#### **WEIGHTS & DIMENSIONS**

#### **Product Weight**

Starting at 3.03 lb <sup>38</sup> Starting at 1.38 kg <sup>38</sup>

#### Product Dimensions (w x d x h)

32.19 x 21.39 x 1.99 cm 12.67 x 8.42 x 0.78 in

38. Weight will vary by configuration.

#### **PORTS/SLOTS**

- 1 SuperSpeed USB Type-C<sup>®</sup> 10 Gbps signaling rate port (Power delivery, DisplayPort™1.4)
- 3 SuperSpeed USB Type-A 5 Gbps signaling rate port (1 charging, 1 powered port)
- 1 HDMI 1.4b 39
- 1 RJ-45
- 1 Headphone/microphone combo jack
- 1 AC power

#### **Expansion Slots**

1 micro SD

Supports SD, SDHC, SDXC

39. HDMI cable sold separately.



### **Technical Specifications**

#### **SERVICE AND SUPPORT**

1-year or 3-year limited warranty and 90-day software limited warranty options depending on country.

Batteries have a default one-year limited warranty except for HP Long Life batteries which will follow the one or three year warranty of the platform. Refer to <a href="http://www.hp.com/support/batterywarranty/">http://www.hp.com/support/batterywarranty/</a>

for additional battery information. On-site service and extended coverage is also available. HP Care Pack Services are optional extended service contracts that go beyond the standard limited warranties. To choose the right level of service for your HP product, use the HP Care Pack Services Lookup Tool at:

http://www.hp.com/go/cpc. 40

40. HP Care Packs are sold separately. Service levels and response times for HP Care Packs may vary depending on your geographic location. Service starts on date of hardware purchase. Restrictions and limitations apply. For details, visit <a href="http://www.hp.com/go/cpc">http://www.hp.com/go/cpc</a>. HP services are governed by the applicable HP terms and conditions of service provided or indicated to Customer at the time of purchase. Customer may have additional statutory rights according to applicable local laws, and such rights are not in any way affected by the HP terms and conditions of service or the HP Limited Warranty provided with your HP Product.



## **Technical Specifications**

#### SYSTEM UNIT

Stand-Alone Power Requirements (AC Power)

Nominal Operating Voltage 19V

Average Operating Power 7.52W (Idle)

Integrated graphics Yes (AMD Radeon™ Graphics)

Discrete Graphics N/A

Discrete < 65W

Max Operating Power UMA < 45W"

**Temperature** 

Operating 32° to 95° F (0° to 35° C) Non-operating -4° to 140° F (-20° to 60° C)

**Relative Humidity** 

Operating 10% to 90%, non-condensing

Non-operating 5% to 95%, 101.6° F (38.7° C) maximum wet bulb temperature

Shock

Operating 40 G, 2 ms, half-sine Non-operating 200 G, 2 ms, half-sine

**Random Vibration** 

Operating 0.75 grms Non-operating 1.50 grms

**Altitude (unpressurized)** 

Operating -50 to 10,000 ft (-15.24 to 3,048 m) Non-operating -50 to 40,000 ft (-15.24 to 12,192 m)

**Planned Industry Standard Certifications** 

UL Yes
CSA Yes
FCC Compliance Yes

ENERGY STAR® Select models<sup>41</sup>

EPEAT® Gold in United States 42

**ICES** Yes Australia / Yes **NZ A-Tick Compliance** Yes CCC Yes Japan VCCI Compliance Yes KC Yes **BSMI** Yes **CE Marking Compliance** Yes **BNCI or BELUS** Yes CIT Yes GOST Yes Saudi Arabian Compliance (ICCP) Yes

41. Configurations of the HP ProBook 445 G8 that are ENERGY STAR® qualified are identified as HP ProBook 445 G8 ENERGY STAR on HP websites and on http://www.energystar.gov.

Yes



**SABS** 

### **Technical Specifications**

42. Based on US EPEAT® registration according to IEEE 1680.1-2018 EPEAT®. EPEAT® status varies by country. Visit http://www.epeat.net for more information

#### **DISPLAYS**

1. Actual brightness will be lower with touchscreen or Sure View.

Note: all specifications represent the typical specifications provided by hp's component manufacturers; actual performance may vary either higher or lower.

Panel LCD 14 inch FHD (1920x1080) Anti-Glare WLED UWVA 45percent cg 250nits eDP 1.2 w/o PSR bent NWBZ **Outline Dimensions (W x H x D)** 316.17 x 186.4 mm (max) (w/ PCB)

**Active Area** 309.37 x 174.02 mm (typ.)

Weight 300 g (max)
Diagonal Size 14.0 inch

Thickness 3.0 mm/ 5.0 mm (PCB) (max)

InterfaceeDP 1.2Surface TreatmentAnti-Glare

Touch Enabled No

Contrast Ratio600:1 (typ.)Refresh Rate60 HzBrightness250 nits

Pixel Resolution 1920 x 1080 (FHD)

Format RGB Stripe
Backlight LED

Color Gamut Coverage NTSC 45%

**Color Depth** 6 bits (Hi FRC supportive w/ condition to enable)

Viewing Angle UWVA 85/85/85



### **Technical Specifications**

Panel LCD 14 inch FHD (1920x1080) Anti-Glare WLED UWVA 72percent cg 1000nits eDP 1.4+PSR2 bent Privacy NB2X Gen3 **Outline Dimensions (W x H x D)** 315.31 x 186.48 mm (max.)

Active Area 309.31 x 173.99
Weight 220g max.
Diagonal Size 14 (inch)
Thickness 3.9 mm max.

Interface eDP 1.4 + PSR (4 lane)
Surface Treatment Anti-Glare (AG)

Touch Enabled No

Contrast Ratio 2000:1 (typ.)

Refresh Rate 60Hz
Brightness 1000 nits
Pixel Resolution 1920x 1080
Format RGB

Format LED

Color Gamut Coverage Adobe RGB 100% STD (95.5% NTSC)

Color Depth 8bits

Viewing Angle UWVA 85/85/85

Panel LCD 14 inch FHD (1920x1080) Anti-Glare WLED UWVA sRGB 100percent cg 400nits eDP 1.4+PSR2 bent LP NB2X 

 Outline Dimensions (W x H x D)
 315.07 x 186.6 mm (max)

 Active Area
 309.37 X 174.02 mm (typ.)

Weight 200 g (max)
Diagonal Size 14.0 inch

Thickness 2.0 mm/4.0 mm (w/PCB) (max)

Interface eDP 1.4
Surface Treatment Anti-Glare
Touch Enabled No

Contrast Ratio 1200:1 (typ.)

Refresh Rate 60 Hz Brightness 400 nits

Pixel Resolution 1920 x 1080 (FHD)

Format RGB Stripe
Backlight LED

Color Gamut Coverage SRGB 100% (NTSC 72%)

Color Depth 6 bits

Viewing Angle UWVA 85/85/85

### **Technical Specifications**

Panel LCD 14-in HD (1366x768) Anti-Glare WLED SVA 45percent cg 250nits eDP 1.2 w/o PSR NWBZ bent Outline Dimensions (W x H x D) 316.1 x 186.37 (mm) max

**Active Area** 309.4 x 173.95 (mm)

Weight 300g Max Diagonal Size 14"

Thickness 3.0t (panel) / 5.0t (panel+PCB) max.

Interface eDP 1.2 (1 lane)
Surface Treatment Anti-Glare

Touch Enabled No

Contrast Ratio300:1 (typ)Refresh Rate60 HzBrightness250nits

Pixel Resolution 1366 x 768 (HD)
Format RGB Stripe

BacklightLEDColor Gamut CoverageNTSC 45%Color Depth6 bits

Viewing Angle SVA 45/45/15/35



### **Technical Specifications**

#### **STORAGE**

For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 30 GB (for Windows 10) is reserved for system recovery software.

SSD 128GB 2280 PCle-3x2 Three

**Layer Cell** 

M.2 2280 Form Factor 128 GB Capacity TLC **NAND Type** 

0.09 in (2.3 mm) Height 0.87 in (22 mm) Width 0.02 lb (10 g) Weight PCIe NVMe Interface

1400 ~ 2100 MB/s Maximum Sequential Read 800 ~ 1200 MB/s Maximum Sequential Write

250,069,680 **Logical Blocks** 

32° to 158°F (0° to 70°C) [ambient temp] **Operating Temperature** ATA Security; DIPM; TRIM; DEVSLP

**Features** 

SSD 1TB 2280 PCIe-3x4 NVMe Three Layer Cell single-sided

M.2 2280 Form Factor 1 TB Capacity TLC **NAND Type** 

0.09 in (2.3 mm) Height 0.87 in (22 mm) Width 0.02 lb (10 g) Weight PCIe NVMe Gen3X4 Interface 3100 ~ 3500 MB/s Maximum Sequential Read 2770 ~ 3037 MB/s Maximum Sequential Write

2,000,409,264 **Logical Blocks** 

32° to 158°F (0° to 70°C) [ambient temp] **Operating Temperature** 

ATA Security; TRIM; L1.2 **Features** 



## **Technical Specifications**

SSD 256GB 2280 PCIe NVMe Value

Capacity 256 GB NAND Type Value

Height 0.09 in (2.3 mm)
Width 0.87 in (22 mm)
Weight 0.02 lb (10 g)
Interface PCIe NVMe Gen3
Maximum Sequential Read 2100 ~ 2200 MB/s
Maximum Sequential Write 900 ~ 1400 MB/s
Logical Blocks 500,118,192

Operating Temperature 32° to 158°F (0° to 70°C) [ambient temp]
Features ATA Security (optional); TRIM; L1.2

SSD 512GB 2280 PCle NVMe Value Capacity 512 GB

NAND Type Value

Height 0.09 in (2.3 mm)
Width 0.87 in (22 mm)
Weight 0.02 lb (10 g)
Interface PCIe NVMe Gen3
Maximum Sequential Read 2200 ~ 2300 MB/s
Maximum Sequential Write 1000 ~ 1600 MB/s
Logical Blocks 1,000,215,215

Operating Temperature 32° to 158°F (0° to 70°C) [ambient temp] Features ATA Security (optional); TRIM; L1.2



### **Technical Specifications**

#### **NETWORKING**

Intel® Wi-Fi 6 AX200 + Bluetooth® 5 (802.11ax 2x2, supporting gigabit data rate ) (non-vPro)<sup>1,5</sup> Wireless LAN Standards

IEEE 802.11a
IEEE 802.11b
IEEE 802.11g
IEEE 802.11n
IEEE 802.11ac
IEEE 802.11ax
IEEE 802.11d
IEEE 802.11t
IEEE 802.11t
IEEE 802.11i
IEEE 802.11k
IEEE 802.11r
IEEE 802.11v

Wifi certified

Interoperability Frequency Band

802.11b/g/n/ax
•2.402 – 2.482 GHz
802.11a/n/ac/ax
•4.9 – 4.95 GHz (Japan)
•5.15 – 5.25 GHz
•5.25 – 5.35 GHz
•5.47 – 5.725 GHz

**Data Rates** 

• 802.11b: 1, 2, 5.5, 11 Mbps

802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps
802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps

802.11n: max 300mbps802.11ac: max 1733Mbps802.11ax: max 2.4Gbps

Modulation

Direct Sequence Spread Spectrum

OFDM, BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM, 1024QAM

Security<sup>3</sup>

• IEEE and WiFi compliant 64 / 128 bit WEP encryption for a/b/g mode only

• AES-CCMP: 128 bit in hardware

802.1x authentication

• WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.

WPA2 certification
WPA3 certification
IEEE 802.11i

WAPI

**Network Architecture** 

Models

Ad-hoc (Peer to Peer)

Infrastructure (Access Point Required)

Roaming

IEEE 802.11 compliant roaming between access points

Output Power<sup>2</sup> • 802.11b: +17dBm minimum • 802.11a: +16dBm minimum

• 802.11g: +16dBm minimum • 802.11a: +17dBm minimum

802.11n HT20(2.4GHz): +14dBm minimum
802.11n HT40(2.4GHz): +13dBm minimum
802.11n HT20(5GHz): +14dBm minimum
802.11n HT40(5GHz): +13dBm minimum
802.11ac VHT80(5GHz): +10dBm minimum



### **Technical Specifications**

802.11ac VHT160(5GHz): +10dBm minimum
802.11ax HE40(2.4GHz): +12dBm minimum
802.11ax HE80(5GHz): +10dBm minimum

• 802.11ax HE160(5GHz): +10dBm minimum

**Power Consumption** •Transmit mode: 2.0 W

•Receive mode 1.6 W

Idle mode (PSP) 180 mW (WLAN Associated)
 Idle mode50 mW (WLAN unassociated)

•Connected Standby 10mW •Radio disabled 8 mW

**Power Management** ACPI and PCI Express compliant power management

802.11 compliant power saving mode

Receiver Sensitivity<sup>4</sup> • 802.11b, 1Mbps: -93.5dBm maximum

802.11b, 11Mbps: -84dBm maximum
802.11a/g, 6Mbps: -86dBm maximum
802.11a/g, 54Mbps: -72dBm maximum
802.11n, MCS07: -67dBm maximum
802.11n, MCS15: -64dBm maximum

802.11ac, MCS0(VHT80): -84dBm maximum
802.11ac, MCS9(VHT80): -59dBm maximum
802.11ac, MCS9(VHT160): -58.5dBm maximum
802.11ax, MCS11(HE40): -57dBm maximum
802.11ax, MCS11(HE80): -54dBm maximum
802.11ax, MCS11(HE160): -53.5dBm maximum

Antenna type High efficiency antenna with spatial diversity, mounted in the display

enclosure

Two embedded dual band 2.4/5 GHz antennas are provided to the card to support WLAN MIMO communications and Bluetooth communications

Form Factor PCI-Express M.2 MiniCard

**Dimensions** 1. Type 2230: 2.3 x 22.0 x 30.0 mm

2. Type 1216: 1.67 x 12.0 x 16.0 mm

**Weight** 1. Type 2230: 2.8g

2. Type 126: 1.3q

Operating Voltage 3.3v +/- 9%

**Temperature** Operating 14° to 158° F (–10° to 70° C)

Non-operating -40° to 176° F (-40° to 80° C)

**Humidity** Operating 10% to 90% (non-condensing)

Non-operating 5% to 95% (non-condensing)

Altitude Operating 0 to 10,000 ft (3,048 m)

Non-operating 0 to 50,000 ft (15,240 m)

LED Amber – Radio OFF; LED OFF – Radio ON

#### HP Integrated Module with Bluetooth 4.0/4.1/4.2/5.0/5.1 Wireless Technology

Bluetooth Specification 4.0/4.1/4.2/5.0/5.1 Compliant

Frequency Band 2402 to 2480 MHz

Number of Available Legacy: 0~79 (1 MHz/CH)

Channels BLE: 0~39 (2 MHz/CH)

**Data Rates and**Legacy: 3 Mbps data rate; throughput up to 2.17 Mbps **Throughput**BLE: 1 Mbps data rate; throughput up to 0.2 Mbps

Legacy: Synchronous Connection Oriented links up to 3, 64 kbps, voice



### **Technical Specifications**

channels

Legacy: Asynchronous Connection Less links 2178.1 kbps/177.1 kbps

asymmetric (3-DH5) or 864 kbps symmetric (3-EV5)

**Transmit Power** 

The Bluetooth component shall operate as a Class II Bluetooth device with a maximum transmit power of + 9.5 dBm for BR and EDR.

- 1. Wireless access point and internet service required and sold separately. Availability of public wireless access points limited. Wi-Fi 6 is backwards compatible with prior 802.11 specs. Only available in countries where 802.11ax is supported.
- 2. The FCC has declared as of September 1, 2014 products that utilize passive scanning on channel 12/13 and are capable of transmitting must fully comply with requirements of 15.247 or otherwise disable those channels.
- 3. Check latest software/driver release for updates on supported security features.
- 4. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).
- 5. Wi-Fi 6 is designed to support gigabit data rate when transferring files between two devices connected to the same router. Requires a wireless router, sold separately, that supports 80MHz and higher channels.



### **Technical Specifications**

Intel® Thunder Peak 9260 Wireless LAN Standards
802.11a/b/g/n/ac (2x2)
WiFi® and Bluetooth® 5.0
Combo¹ (Non-vPro)

EEE 802.11a
IEEE 802.11a
IEEE 802.11a
IEEE 802.11a

IEEE 802.11ac
IEEE 802.11d
IEEE 802.11e
IEEE 802.11h
IEEE 802.11i
IEEE 802.11k
IEEE 802.11r
IEEE 802.11v
Wi-Fi certified
802.11b/g/n

**Interoperability** Wi-Fi certified 802.11b/g/n

•2.402 – 2.482 GHz 802.11a/n/ac

•4.9 – 4.95 GHz (Japan) •5.15 – 5.25 GHz •5.25 – 5.35 GHz •5.47 – 5.725 GHz •5.825 – 5.850 GHz

**Data Rates** • 802.11b: 1, 2, 5.5, 11 Mbps

802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps
802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps

802.11n: max 300Mbps802.11ac: max 1733Mbps

**Modulation** Direct Sequence Spread Spectrum

BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM

•IEEE compliant 64 / 128-bit WEP encryption for a/b/g mode only

•AES-CCMP: 128 bit in hardware

•802.1x authentication

•WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.

WPA2 certificationWPA3 certificationIEEE 802.11iWAPI

**Network Architecture** 

Models

Ad-hoc (Peer to Peer)

Infrastructure (Access Point Required)

**Roaming** IEEE 802.11 compliant roaming between access points

Output Power<sup>2</sup>
• 802.11b: +17dBm minimum
• 802.11g: +16dBm minimum

• 802.11g: +16dBm minimum • 802.11a: +17dBm minimum

802.11n HT20(2.4GHz): +14dBm minimum
802.11n HT40(2.4GHz): +13dBm minimum
802.11n HT20(5GHz): +14dBm minimum
802.11n HT40(5GHz): +13dBm minimum
802.11ac VHT80(5GHz): +10dBm minimum

• 802.11ac VHT160(5GHz): +10dBm minimum

Power Consumption • Transmit mode: 2.0 W

•Receive mode 1.6 W



### **Technical Specifications**

•Idle mode (PSP) 180 mW (WLAN Associated)
•Idle mode50 mW (WLAN unassociated)

•Idle mode50 mw (WLAN unass
•Connected Standby 10mW

•Radio disabled 8 mW

**Power Management** ACPI and PCI Express compliant power management

802.11 compliant power saving mode

Receiver Sensitivity<sup>4</sup> • 802.11b, 1Mbps: -93.5dBm maximum

802.11b, 11Mbps: -84dBm maximum
802.11a/g, 6Mbps: -86dBm maximum
802.11a/g, 54Mbps: -72dBm maximum
802.11n, MCS07: -67dBm maximum
802.11n, MCS15: -64dBm maximum
802.11ac, MCS0(VHT80): -84dBm maximum

802.11ac, MCS0(VHT80): -84dBm maximum
802.11ac, MCS9(VHT80): -59dBm maximum
802.11ac, MCS9(VHT160): -58.5dBm maximum

Antenna type High efficiency antenna with spatial diversity, mounted in the display

enclosure

Two embedded dual band 2.4/5 GHz antennas are provided to the card to support WLAN MIMO communications and Bluetooth communications

Form Factor PCI-Express M.2 MiniCard

**Dimensions** 1. Type 2230: 2.3 x 22.0 x 30.0 mm

2. Type 1216: 1.67 x 12.0 x 16.0 mm

**Weight** 1. Type 2230: 2.8g

2. Type 126: 1.3g

Operating Voltage 3.3v +/- 9%

**Temperature** Operating 14° to 158° F (–10° to 70° C)

Non-operating -40° to 176° F (-40° to 80° C)

**Humidity** Operating 10% to 90% (non-condensing)

Non-operating 5% to 95% (non-condensing)

**Altitude** Operating 0 to 10,000 ft (3,048 m)

Non-operating 0 to 50,000 ft (15,240 m)

LED Activity LED Amber – Radio OFF; LED OFF – Radio ON

#### HP Integrated Module with Bluetooth 4.0/4.1/4.2/5.0 Wireless Technology

**Bluetooth Specification** 4.0/4.1/4.2/5.0 Compliant

Frequency Band 2402 to 2480 MHz

Number of Available Legacy: 0~79 (1 MHz/CH)

Channels BLE: 0~39 (2 MHz/CH)

**Data Rates and**Legacy: 3 Mbps data rate; throughput up to 2.17 Mbps **Throughput**BLE: 1 Mbps data rate; throughput up to 0.2 Mbps

Legacy: Synchronous Connection Oriented links up to 3, 64 kbps, voice

channels

Legacy: Asynchronous Connection Less links 2178.1 kbps/177.1 kbps

asymmetric (3-DH5) or 864 kbps symmetric (3-EV5)

Transmit Power The Bluetooth component shall operate as a Class II Bluetooth device with

a maximum transmit power of + 4 dBm for BR and EDR.

1. Wireless access point and internet service required and sold separately. Availability of public wireless access points limited. Wi-Fi 5 (802.11 ac) is backwards compatible with prior 802.11 specs.

2. The FCC has declared as of September 1, 2014 products that utilize passive scanning on channel 12/13 and are capable of



### **Technical Specifications**

transmitting must fully comply with requirements of 15.247 or otherwise disable those channels.

- 3. Check latest software/driver release for updates on supported security features.
- 4. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).



### **Technical Specifications**

Realtek RTL8822CE 802.11ac 2x2 Wi-Fi® + Bluetooth® 51

Wireless LAN Standards IEEE 802.11a

IEEE 802.11b IEEE 802.11q

IEEE 802.11n IEEE 802.11ac

IEEE 802.11d IEEE 802.11e IEEE 802.11h IEEE 802.11i IEEE 802.11k

IEEE 802.11r IEEE 802.11v

Interoperability Wi-Fi certified modules

**Frequency Band** 802.11b/g/n

•2.402 - 2.482 GHz

802.11a/n/ac

•4.9 - 4.95 GHz (Japan) •5.15 - 5.25 GHz •5.25 - 5.35 GHz •5.47 - 5.725 GHz •5.825 - 5.850 GHz

**Data Rates** •802.11b: 1, 2, 5.5, 11 Mbps

> •802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps •802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps

•802.11n: max 300Mbps •802.11ac: max 866.7Mbps

Modulation Direct Sequence Spread Spectrum

BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM

Security<sup>3</sup> •IEEE and Wi-Fi certified 64 / 128-bit WEP encryption for a/b/g mode only

AES-CCMP: 128 bit in hardware

•802.1x authentication

•WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.

 WPA2 certification WPA3 certification •IEEE 802.11i •WAPI

**Network Architecture** 

Ad-hoc (Peer to Peer)

Models Infrastructure (Access Point Required)

Roaming IEEE 802.11 compliant roaming between access points

Output Power<sup>2</sup> • 802.11b: +18.5dBm minimum

• 802.11g: +17.5dBm minimum 802.11a: +18.5dBm minimum

 802.11n HT20(2.4GHz): +15.5dBm minimum 802.11n HT40(2.4GHz): +14.5dBm minimum 802.11n HT20(5GHz): +15.5dBm minimum 802.11n HT40(5GHz): +14.5dBm minimum 802.11ac VHT80(5GHz): +11.5dBm minimum

**Power Consumption** Transmit mode: 2.0 W

•Receive mode 1.6 W

Idle mode (PSP) 180 mW (WLAN Associated)



### **Technical Specifications**

•Idle mode50 mW (WLAN unassociated)
•Connected Standby/Modern Standby: 10mW

Radio disabled 8 mW

**Power Management** ACPI and PCI Express compliant power management

802.11 compliant power saving mode

**Receiver Sensitivity<sup>4</sup>** •802.11b, 1Mbps: -93.5dBm maximum

•802.11b, 11Mbps: -84dBm maximum
•802.11a/g, 6Mbps: -86dBm maximum
•802.11a/g, 54Mbps: -72dBm maximum
•802.11n, MCS07: -67dBm maximum
•802.11n, MCS15: -64dBm maximum
•802.11ac, MCS0: -84dBm maximum
•802.11ac, MCS9: -59dBm maximum

Antenna type High efficiency antenna with spatial diversity, mounted in the display

enclosure

Two embedded dual band 2.4/5 GHz antennas are provided to the card to support WLAN MIMO communications and Bluetooth communications

Form Factor PCI-Express M.2 MiniCard

**Dimensions** 1. Type 2230: 2.3 x 22.0 x 30.0 mm

2. Type 1216: 1.67 x 12.0 x 16.0 mm

**Weight** 1. Type 2230: 2.8g

2. Type 126: 1.3g

Operating Voltage 3.3v +/- 9%

**Temperature** Operating 14° to 158° F (–10° to 70° C)

Non-operating  $-40^{\circ}$  to  $176^{\circ}$  F ( $-40^{\circ}$  to  $80^{\circ}$  C)

**Humidity** Operating 10% to 90% (non-condensing)

Non-operating 5% to 95% (non-condensing)

**Altitude** Operating 0 to 10,000 ft (3,048 m)

Non-operating 0 to 50,000 ft (15,240 m)

LED Amber – Radio OFF; LED OFF – Radio ON

#### HP Integrated Module with Bluetooth 4.0/4.1/4.2/5.0 Wireless Technology

**Bluetooth Specification** 4.0/4.1/4.2/5.0 Compliant

Frequency Band 2402 to 2480 MHz

Number of Available Legacy: 0~79 (1 MHz/CH)
Channels BLE: 0~39 (2 MHz/CH)

**Data Rates and**Legacy: 3 Mbps data rate; throughput up to 2.17 Mbps **Throughput**BLE: 1 Mbps data rate; throughput up to 0.2 Mbps

Legacy: Synchronous Connection Oriented links up to 3, 64 kbps, voice

channels

Legacy: Asynchronous Connection Less links 2178.1 kbps/177.1 kbps

asymmetric (3-DH5) or 864 kbps symmetric (3-EV5)

**Transmit Power** The Bluetooth component shall operate as a Class II Bluetooth device with

a maximum transmit power of + 4 dBm for BR and EDR.

1. Wireless access point and internet service required and sold separately. Availability of public wireless access points limited. Wi-Fi 5 (802.11 ac) is backwards compatible with prior 802.11 specs.

2. The FCC has declared as of September 1, 2014 products that utilize passive scanning on channel 12/13 and are capable of transmitting must fully comply with requirements of 15.247 or otherwise disable those channels.
 3. Check latest software/driver release for updates on supported security features.



## **Technical Specifications**

4. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).



### **Technical Specifications**

Qualcomm WCN6856 Wi-Fi 6E and Bluetooth® 5.2 (802.11ax 2x2, AMD AIM-T AME, supporting gigabit file transfer speeds) 1,5 Wireless LAN Standards IEEE 8

IEEE 802.11a IEEE 802.11b IEEE 802.11g

IEEE 802.11n IEEE 802.11ac IEEE 802.11ax

IEEE 802.11d IEEE 802.11d IEEE 802.11e IEEE 802.11h IEEE 802.11i

IEEE 802.11k IEEE 802.11r IEEE 802.11u IEEE 802.11v IEEE 802.11w

Interoperability Wi-Fi certified
Frequency Band •802.11b/g/n/ax

2.402 – 2.482 GHz •802.11a/n/ac/ax 5.15 – 5.25 GHz 5.25 – 5.35 GHz 5.47 – 5.725 GHz 5.825 – 5.850 GHz 5.925 – 7.125 GHz

**Data Rates** • 802.11b: 1, 2, 5.5, 11 Mbps

802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps
802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps
802.11n: MCS 0 ~ MCS 15, (20MHz, and 40MHz)

• 802.11ac : MCS0 ~ MCS9, (1SS, and 2SS) (20MHz, 40MHz, ,80MHz &

160MHz)

802.11ax: MCS0 ~ MCS11, (1SS and 2SS) (20MHz, 40MHz, ,80MHz &

160MHz)

**Modulation** Direct Sequence Spread Spectrum

OFDM, BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM

, 1024QAM, 4096QAM

• AES-CCMP: 128 bit in hardware

802.1x authentication

• WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.

WPA2 certificationIEEE 802.11i

**Network Architecture** 

Models

**Output Power<sup>2</sup>** 

Wi-Fi Direct in Win10 for peer-to-peer connection.

Infrastructure (Access Point Required)

**Roaming** IEEE 802.11 compliant roaming between access points

•2.4GHz (MIMO, typical): 802.11b : +18dBm

802.11g:+16.5dBm

802.11n/ac/ax (HT20/VHT20/HE20) : +16dBm 802.11n/ac/ax (HT40/VHT40/HE40) : +12.5dBm

•5GHz (MIMO, typical): 802.11a : +13dBm

802.11n/ac/ax (HT20/VHT20/HE20): +13.5dBm

### **Technical Specifications**

802.11n/ac/ax (HT40/VHT40/HE40): +12.5dBm

802.11ac/ax (VHT80/HE80): +11.5dBm

802.11ax HE160 : +11.5dBm •6GHz LPI mode (MIMO, typical)::

802.11a:0dBm

802.11ax HE20:+1dBm 802.11ax HE40:+4dBm 802.11ax HE80:+7dBm 802.11ax HE160:+7.5dBm

Power Consumption • Transmit mode: 3.0 W

• Receive mode: 2.0 W

Idle mode (WLAN associated): 300mW
 Idle mode (WLAN unassociated): 100mW
 Modern Connected Standby: 10mW

Radio disabled: 8 mW

**Power Management** ACPI and PCI Express compliant power management

802.11 compliant power saving mode

**Receiver Sensitivity<sup>4</sup>** 2.4GHz (SISO):

802.11b, 11Mbps: -82dBm maximum
802.11g, 54Mbps: -71dBm maximum
802.11n, MCS7: -64dBm maximum
802.11ac, MCS9: -52dBm maximum
802.11ax, MCS11(HT40): -49dBm maximum

5GHz (SISO):

802.11a, 54Mbps: -71dBm maximum
802.11n, MCS07: -64dBm maximum
802.11ac, MCS9: -52dBm maximum

•802.11ax, MCS11(HE80/HE160): -46dBm maximum

6GHz (SISO):

802.11a, 54Mbps: -71dBm maximum
 802.11n, MCS7: -64dBm maximum
 802.11ac, MCS9: -52dBm maximum

•802.11ax, MCS11(HE160): -46dBm maximum

Antenna type High efficiency antenna with spatial diversity, mounted in the display

enclosure

Two embedded dual band 2.4/5/6 GHz antennas are provided to the card to support WLAN MIMO communications and Bluetooth communications

Form Factor PCI-Express M.2 MiniCard

**Dimensions** Type 2230 : 2.3 x 22.0 x 30.0 mm

Weight Type 2230 : 3g
Operating Voltage 3.3 +/ 0.165v

**Temperature** Operating: −10° to 60° C

Non-operating -40° to 85° C

**Humidity** Operating: 10% to 60% (non-condensing)

Non-operating: 5% to 95% (non-condensing)

Altitude Operating: 0 to 10,000 ft (3,048 m)

Non-operating: 0 to 50,000 ft (15,240 m)

LED Activity N/A

HP Integrated Module with Bluetooth 4.0/4.1/4.2/5.0/5.1/5.2 Wireless Technology



### **Technical Specifications**

**Bluetooth Specification** 4.0/4.1/4.2/5.0/5.1/5.2 Compliant

Frequency Band 2402 to 2480 MHz

Number of Available Legacy : 0~79 (1 MHz/CH)
Channels BLE : 0~39 (2 MHz/CH)

**Data Rates and**Legacy: 3 Mbps data rate; throughput up to 2.17 Mbps **Throughput**BLE: 1 Mbps data rate; throughput up to 0.2 Mbps

Legacy: Synchronous Connection Oriented links up to 3, 64 kbps, voice

channels

Legacy: Asynchronous Connection Less links 2178.1 kbps/177.1 kbps

asymmetric (3-DH5) or 864 kbps symmetric (3-EV5)

**Transmit Power** The Bluetooth component shall operate as a Class 1.5 Bluetooth device

with a maximum transmit power of + 14 dBm and 10 dBm for BR and EDR,

respectively.

**Power Consumption** Peak (Tx): 330 mW

Peak (Rx): 230 mW

**Bluetooth Software** 

Supported

Microsoft Windows Bluetooth Software

**Link Topology** 

Power Management Microsoft Windows ACPI, and USB Bus Support Certifications FCC (47 CFR) Part 15C, Section 15.247 & 15.407

Power Management ETS 300 328

Low Voltage Directive

**Certifications** CE Mark

**Bluetooth Profiles** 

Supported

BT4.1-ESR 5/6/7 Compliance

LE Link Layer Ping LE Dual Mode LE Link Layer

LE Low Duty Cycle Directed Advertising LE L2CAP Connection Oriented Channels

Train Nudging & Interlaced Scan

BT4.2 ESR08 Compliance

LE Secure Connection- Basic/Full LE Privacy 1.2 -Link Layer Privacy

LE Privacy 1.2 - Extended Scanner Filter Policies

LE Data Packet Length Extension

FAX Profile (FAX)

Basic Imaging Profile (BIP)2 Headset Profile (HSP) Hands Free Profile (HFP)

Advanced Audio Distribution Profile (A2DP)

**Security & Manageability** AMD AIM-T AME support with appropriate AMD chipset components

1. Wi-Fi 6E requires a Wi-Fi 6E router, sold separately, to function in the 6GHz band. Availability of public wireless access points limited. Wi-Fi 6E is backwards compatible with prior 802.11 specs. And available in countries where Wi-Fi 6E is supported 2. The FCC has declared as of September 1, 2014 products that utilize passive scanning on channel 12/13 and are capable of transmitting must fully comply with requirements of 15.247 or otherwise disable those channels.

3. Check latest software/driver release for updates on supported security features.

4. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).

5. Wi-Fi 6E is designed to support gigabit data rate when transferring files between two devices connected to the same router. Requires a wireless router, sold separately, that supports 80MHz and higher channels.

### **Technical Specifications**

Mediatek MT7921 Wi-Fi 6 Wireless LAN Standards IEEE 802.11a and Bluetooth® 5.2 IEEE 802.11b IEEE 802.11g IEEE 802.11g IEEE 802.11n IEEE 802.11n IEEE 802.11ac IEEE 802.11ac

IEEE 802.11ax IEEE 802.11d IEEE 802.11e IEEE 802.11h IEEE 802.11i IEEE 802.11k IEEE 802.11r IEEE 802.11v

Interoperability Wi-Fi certified modules
Frequency Band •802.11b/g/n/ax

2.402 – 2.482 GHz •802.11a/n/ac/ax 4.9 – 4.95 GHz (Japan) 5.15 – 5.25 GHz 5.25 – 5.35 GHz 5.47 – 5.725 GHz 5.825 – 5.850 GHz

**Data Rates** • 802.11b: 1, 2, 5.5, 11 Mbps

802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps
802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps

802.11n: max 300Mbps
802.11ac: max 866.7Mbps
802.11ax: max 1201Mbps

Modulation DSSS, OFDM, DBPSK, DQPSK, CCK, 16 QAM, 64 QAM, 256 QAM,

1024 QAM

• IEEE and WiFi certified 64 / 128 bit WEP encryption for a/b/g mode only

• AES-CCMP: 128 bit in hardware

• 802.1x authentication

• WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.

WPA2 certification
WPA3 certification
IEEE 802.11i

WAPI

**Network Architecture** 

Models Roaming Ad-hoc (Peer to Peer)

Infrastructure (Access Point Required)

**Output Power[2]** • 802.11b: +18.5dBm minimum

• 802.11g : +17.5dBm minimum • 802.11a : +18.5dBm minimum

802.11n HT20(2.4GHz): +15.5dBm minimum
 802.11n HT40(2.4GHz): +14.5dBm minimum
 802.11n HT20(5GHz): +15.5dBm minimum
 802.11n HT40(5GHz): +14.5dBm minimum

IEEE 802.11 compliant roaming between access points

### **Technical Specifications**

802.11ac VHT80(5GHz): +11.5dBm minimum
 802.11ax HE40(2.4GHz): +10dBm minimum

• 802.11ax HE80(5GHz): +10dBm minimum

Power Consumption • Transmit mode :2.5 W

• Receive mode: 2 W

Idle mode (PSP) 180 mW (WLAN Associated)
Idle mode :50 mW (WLAN unassociated)
Connected Standby/Modern Standby: 10mW

• Radio disabled: 8 mW

**Power Management** ACPI and PCI Express compliant power management

802.11 compliant power saving mode

**Receiver Sensitivity<sup>3</sup>** 802.11b, 1Mbps: -93.5dBm maximum 802.11b, 11Mbps: -84dBm maximum

802.11a/g, 6Mbps: -84dBm maximum 802.11a/g, 54Mbps: -72dBm maximum 802.11n, MCS07: -67dBm maximum 802.11n, MCS15: -64dBm maximum 802.11ac, MCS0: -84dBm maximum 802.11ac, MCS9: -59dBm maximum

•802.11ax, MCS11(HE40): -57dBm maximum •802.11ax, MCS11(HE80): -54dBm maximum

Antenna type High efficiency antenna with spatial diversity, mounted in the display

enclosure

Two embedded dual band 2.4/5 GHz antennas are provided to the card to support WLAN MIMO communications and Bluetooth communications

Form Factor PCI-Express M.2 MiniCard

**Dimensions** 1. Type 2230 : 2.3 x 22.0 x 30.0 mm

**Weight** 1. Type 2230 : 2.8g

Operating Voltage 3.3v +/- 9%

**Temperature** Operating: 14° to 158° F (–10° to 70° C)

Non-operating: -40° to 176° F (-40° to 80° C)

**Humidity** Operating: 10% to 90% (non-condensing)

Non-operating: 5% to 95% (non-condensing)

Altitude Operating: 0 to 10,000 ft (3,048 m)

Non-operating: 0 to 50,000 ft (15,240 m)

LED Activity LED Amber – Radio OFF; LED OFF – Radio ON

#### HP Integrated Module with Bluetooth 4.0/4.1/4.2/5.0/5.1/5.2 Wireless Technology

**Bluetooth Specification** 4.0/4.1/4.2/5.0/5.1 Compliant

Frequency Band 2402 to 2480 MHz

**Number of Available** Legacy : 0~79 (1 MHz/CH) **Channels** BLE : 0~39 (2 MHz/CH)

Data Rates andLegacy: 3 Mbps data rate; throughput up to 2.17 MbpsThroughputBLE: 1 Mbps data rate; throughput up to 0.2 Mbps

Legacy: Synchronous Connection Oriented links up to 3, 64 kbps, voice

channels

Legacy: Asynchronous Connection Less links 2178.1 kbps/177.1 kbps

asymmetric (3-DH5) or 864 kbps symmetric (3-EV5)

**Transmit Power** The Bluetooth component shall operate as a Class II Bluetooth device with

### **Technical Specifications**

a maximum transmit power of + 4 dBm for BR and EDR.

Power Consumption Peak (Tx): 330 mW

Peak (Rx): 230 mW

Selective Suspend: 17 mW

Bluetooth Software

Supported

Microsoft Windows Bluetooth Software

**Link Topology** 

**Power Management** Microsoft Windows ACPI, and USB Bus Support **Certifications** FCC (47 CFR) Part 15C, Section 15.247 & 15.249

Power Management ETS 300 328, ETS 300 826

Low Voltage Directive IEC950

**Certifications** UL, CSA, and CE Mark

Bluetooth Profiles

Supported

BT4.1-ESR 5/6/7 Compliance

LE Link Layer Ping LE Dual Mode LE Link Layer

LE Low Duty Cycle Directed Advertising LE L2CAP Connection Oriented Channels

Train Nudging & Interlaced Scan BT4.2 ESR08 Compliance

LE Secure Connection- Basic/Full LE Privacy 1.2 -Link Layer Privacy

LE Privacy 1.2 - Extended Scanner Filter Policies

LE Data Packet Length Extension

FAX Profile (FAX)

Basic Imaging Profile (BIP)2 Headset Profile (HSP) Hands Free Profile (HFP)

Advanced Audio Distribution Profile (A2DP)

BT5.1

ESR9/10 Compliance LE Advertisement Extensions Channel Selection Algo

Limited High Duty Cycle Non-Connectable Advertising

2Mbps LE LE Long Range

- 1. Wireless access point and Internet service required and sold separately. Availability of public wireless access points limited. Wi-Fi 6 (802.11ax) is backwards compatible with prior 802.11 specs.
- 2. The FCC has declared as of September 1, 2014 products that utilize passive scanning on channel 12/13 and are capable of transmitting must fully comply with requirements of 15.247 or otherwise disable those channels.
- 3. Check latest software/driver release for updates on supported security features.
- 4. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).
- 5. Wi-Fi 6 is designed to support gigabit data rate when transferring files between two devices connected to the same router. Requires a wireless router, sold separately, that supports 80MHz and higher channels.



### **Technical Specifications**

#### Realtek RTK8111HSH 10/100/1000 Integrated NIC

Ethernet Features 10 Mbit/s operation (10BASE-T; IEEE 802.3i; IEEE 802.3 clauses 13-14)

100 Mbit/s operation (100BASE-TX; IEEE 802.3u; IEEE 802.3 clauses 21-

30)

1000 Mbit/s operation (1000BASE-T; IEEE 802.3ab; IEEE 8023 clauses 40)

Auto-Negotiation (Automatic Speed Selection)

Full Duplex Operation at all Speeds, Half Duplex operation at 10 and 100

Mbit/s

**Power Management** ACPI compliant – multiple power modes

Situation-sensitive features reduce power consumption

Advanced link down power saving for reducing link down power

consumption

Performance Features TCP/IP/UDP Checksum Offload (configurable)

Protocol Offload (ARP & NS)

Large send offload and Giant send offload

Receiving Side Scaling Jumbo Frame 9K

Manageability Wake-on-LAN from modern standby or sleep state (Magic Packet and

Microsoft Wake-Up Frame); Wake-on-LAN from off (Magic Packet only)

PXE 2.1 Remote Boot

Statistics Gathering (SNMP MIB II, Ethernet-like MIB, Ethernet MIB (802.3x,

clause 30))

Comprehensive diagnostic and configuration software suite

Virtual Cable Doctor for Ethernet cable status

Interface Auto MDI/MDIX Crossover cable detection

NIC Device Driver Name Realtek PCIe GBE Ethernet Family Controller



### **Technical Specifications**

#### **POWER**

AC Adapter 45 Watt Smart Dimensions nPFC Standard Barrel 4.5mm Right Angle 1.8m

95x45x26.8mm Weight unit: 200g +/- 10g

Input

**Input Efficiency** 87.74 % at 115 Vac and 88.4 % at 230Vac

Input frequency range 47 ~ 63 Hz

**Input AC current** Max. 1.4 A at 90 Vac

Output

**Output power** 45W DC output 19.5V

Hold-up time 5ms at 115 Vac input

**Output current limit** <8.0A

Connector

Connector 4.5mm Barrel Type

**Environmental Design** 

Operating temperature 32oF to 95oF (0° to 35°C)

Non-operating (storage)

temperature

-4oF to 185oF (-20° to 85°C)

Non-operating (storage)

temperature

Altitude 0 to 16,400 ft (0 to 5000m)

**Humidity** 20% to 95% Storage Humidity 10% to 95%

> Eq: \*CE Mark - full compliance with LVD and EMC directives \* Worldwide safety standards - IEC60950, EN60950, UL60950, Class1, SELV; Agency

approvals - C-UL-US, NORDICS, DENAN, EN55022 Class B, FCC Class B,

**EMI and Safety Certifications** CISPR22 Class B, CCC, NOM-1 NYCE. \* MTBF - over 200,000 hours at

25°C ambient condition.



### **Technical Specifications**

AC Adapter 45 Watt nPFC Standard USB type C Straight 1.8m **Dimensions** 94.0mm \* 40.0mm \* 26.5mm

**Weight** 192.5g +/-10%

Input

**Input Efficiency** Average Efficiency of 25%, 50%, 75%, 100% load condition with

115Vac/230Vac Spec:

5V: 81.5% 9V: 86.7% 12V: 87.41% 15V: 87.8% 47 ~ 63Hz

Input frequency range

**Input AC current** 

Output

Max. 1.4 A at 90 Vac

5V/15W 9V/27W 12V/36W

Output power 15V/45W
DC output 5V/9V/12V/15V
Hold-up time 5ms at 115 Vac input

**Output current limit** 

Connector USB Type-C™

**Operating temperature** 32°F to 95°F (0°to 35°C)

Non-operating (storage)

temperature

-4°F to 185°F (-20° to 85°C)

**Altitude** 0 to 16,400 ft (0 to 5000m)

**Humidity** 20% to 95% **Storage Humidity** 10% to 95%

**EMI and Safety Certifications** Eg:

\*CE Mark - full compliance with LVD and EMC directives

\* Worldwide safety standards - IEC60950, EN60950, UL60950, Class1, SELV; Agency approvals - C-UL-US, NORDICS, DENAN, EN55022 Class B. FCC Class B. CISPR22 Class B. CCC. NOM-1 NYCE.

### **Technical Specifications**

AC Adapter 45 Watt Smart nPFC Standard Barrel 4.5mm Right Angle 1.8m 2prong 
 Dimensions
 95x45x26.8mm

 Weight
 unit: 200g +/- 10g

Input

**Input Efficiency** 87.74 % at 115 Vac and 88.4 % at 230 Vac

Input frequency range 47 ~ 63 Hz

Input AC current

Output

Max. 1.4 A at 90 Vac

Output power 45W DC output 19.5V

**Hold-up time** 5ms at 115 Vac input

Output current limit <8.0A

Connector 4.5mm Barrel Type
Operating temperature 32°F to 95°F (0°to 35°C)

Non-operating (storage)

temperature

-4°F to 185°F (-20° to 85°C)

**Altitude** 0 to 16,400 ft (0 to 5000m)

**Humidity** 20% to 95% **Storage Humidity** 10% to 95%

**EMI and Safety Certifications** Eg:

\*CE Mark - full compliance with LVD and EMC directives

\* Worldwide safety standards - IEC60950, EN60950, UL60950, Class1, SELV; Agency approvals - C-UL-US, NORDICS, DENAN, EN55022 Class B, FCC Class B, CISPR22 Class B, CCC, NOM-1 NYCE.



### **Technical Specifications**

AC Adapter 65 Watt nPFC Standard USB type C©Straight 1.8m 
 Dimensions
 90.0x51x28.5mm

 Weight
 unit: 250g +/- 10g

Input

**Input Efficiency** 81.5% min at 115 Vac/ 230Vac @ 5V/3A

86.7% min at 115 Vac/ 230Vac @ 9V/3A 88% min at 115 Vac/ 230Vac @ 12V/5A 89% min at 115 Vac/ 230Vac @ 15V/4.33A 89% min at 115 Vac/ 230Vac @ 20V/3.25A

Input frequency range 47 ~ 63 Hz

**Input AC current** 

Output

1.6 A at 90 VAC and maximum load

Output power 65W

DC output 5V/9V/12V/15V/20V Hold-up time 5v/9V/12V/15V/20V

**Operating temperature** 32°F to 95°F (0°to 35°C)

Non-operating (storage)

temperature

-4°F to 185°F (-20° to 85°C)

**Altitude** 0 to 16,400 ft (0 to 5000m)

**Humidity** 20% to 95% **Storage Humidity** 10% to 95%

**EMI and Safety Certifications** Eq:

\*CE Mark - full compliance with LVD and EMC directives

\* Worldwide safety standards - IEC60950, EN60950, UL60950, Class1, SELV; Agency approvals - C-UL-US, NORDICS, DENAN, EN55022 Class B, FCC Class B, CISPR22 Class B, CCC, NOM-1 NYCE.



### **Technical Specifications**

AC Adapter 65 Watt Smart nPFC EM Barrel 4.5mm New EM 
 Dimensions
 102 x 55 x 30mm

 Weight
 unit: 250g +/- 10g

Input

**Input Efficiency** 88.0 % at 115 Vac and 89.0 % at 230 Vac

Input frequency range 47 ~ 63 Hz

Input AC current Max. 1.7 A at 90 Vac

Output

Output power 65W 19.5V

**Hold-up time** 5ms at 115 Vac input

Output current limit <11.0A

**Connector** 4.5mm Barrel Type **Operating temperature** 32°F to 95°F (0°to 35°C)

Non-operating (storage)

temperature

-4°F to 185°F (-20° to 85°C)

Altitude 0 to 16,400 ft (0 to 5000m)

**Humidity** 20% to 95% **Storage Humidity** 10% to 95%

**EMI and Safety Certifications** Eg:

\*CE Mark - full compliance with LVD and EMC directives

\* Worldwide safety standards - IEC60950, EN60950, UL60950, Class1, SELV; Agency approvals - C-UL-US, NORDICS, DENAN, EN55022 Class B, FCC Class B, CISPR22 Class B, CCC, NOM-1 NYCE.

### **Technical Specifications**

AC Adapter 65 Watt Smart nPFC Standard Barrel 4.5mm Right Angle 1.8m 
 Dimensions
 90 x 51 x 28.5mm

 Weight
 unit: 230g +/- 10g

Input

**Input Efficiency** 88.0 % at 115 Vac and 89.0 % at 230 Vac

Input frequency range 47 ~ 63 Hz

Input AC current

Output

Max. 1.7 A at 90 Vac

Output power 65W 19.5V

Hold-up time 5ms at 115 Vac input

Output current limit <11.0A

**Connector** 4.5mm Barrel Type **Operating temperature** 32°F to 95°F (0°to 35°C)

Non-operating (storage)

temperature

-4°F to 185°F (-20° to 85°C)

**Altitude** 0 to 16,400 ft (0 to 5000m)

Humidity 20% to 95% Storage Humidity 10% to 95%

**EMI and Safety Certifications** Eg:

\*CE Mark - full compliance with LVD and EMC directives

\* Worldwide safety standards - IEC60950, EN60950, UL60950, Class1, SELV; Agency approvals - C-UL-US, NORDICS, DENAN, EN55022 Class B, FCC Class B, CISPR22 Class B, CCC, NOM-1 NYCE.

\* MTBF - over 200,000 hours at 25°C ambient condition.

Battery RH 3 Cell 45Wh Long Life -PL Fast Charge Dimensions (H x W x L)

6.2 x 68.7 x 249.6mm

Weight 190g

Cells/Type 3cell Lithium-Ion Polymer cell/ 545974

Energy

Voltage 11.4V Amp-hour capacity 3.950Ah Watt-hour capacity 45Wh

**Temperature** 

Operating (Charging) 32° to 113° F (0° to 45° C)
Operating (Discharging) 14° to 122° F (-10° to 60° C)

Fuel Gauge LED NA

Warranty Based on system offering

Optional Travel Battery

Available

No



### **Technical Specifications**

#### **FINGERPRINT READER**

Model: Elan efsa80ST (module P1515B) Mobile Voltage Operation: 2.7V to 3.6V

Operating Temperature: -4°F - 175°F (-20° ~ +80°C)

Current Consumption Image: 50mA peak Low Latency Wait For Finger: 900uA

Capture Rate: 30 frame/sec ESD Resistance: +15KV

Detection Matrix: 80\*80 pixels/ 508 dpi / 4\*4mm sensor area

FRR (False Reject Rate) / FAR (False Acceptance Rate): FRR: <3%, FAR: 1/100K

#### **ENVIRONMENTAL DATA**

Eco-Label Certifications & declarations	This product has received or is in the process of being certified to the following approvals and may be labeled with one or more of these marks:  • IT ECO declaration • US ENERGY STAR®			
	<ul> <li>US Federal Energy Management Program (FEMP)</li> <li>EPEAT<sup>®</sup> Gold registered in the United States. See http://www.epeat.net for registration status in your country.</li> <li>TCO 8.0</li> <li>China Energy Conservation Program (CECP)</li> <li>China State Environmental Protection Administration (SEPA)</li> <li>Taiwan Green Mark</li> <li>Korea Eco-label</li> <li>Japan PC Green label*</li> </ul>			
Sustainable Impact	• Ocean-bound plastic in ()	part(s))		
Specifications	• 12.98% post-consumer recycled plastic			
	• External Power Supply 90% Efficiency			
	• Low halogen			
	Outside Box and corrugated cushions are 100% sustainably sourced and recyclable			
	Molded Paper Pulp Cushion inside box is 100% sustainably sourced and recyclable			
	Recycled Plastic cushions			
	Bulk packaging available			
System Configuration	The configuration used for the Energy Consumption and Declared Noise Emissions data for the Notebook model is based on a "Typically Configured Notebook".			
Energy Consumption (in accordance with US ENERGY STAR® test method)	115VAC, 60Hz	230VAC, 50Hz	100VAC, 50Hz	
Normal Operation (Sort	4.32 W	4.52 W	4.42 W	
idle)				
Normal Operation (Long	0.60 W	0.63 W	0.60 W	
idle)				
Sleep	0.60 W 0.63 W 0.60 W			



### Technical Specifications

Off	0.28	N	0.31 W		0.28 W	
	family. HP con Environmental family does no	nputers mark I Protection <i>I</i> ot offer ENERO configured I	ed with the ENERGY S Agency (EPA) ENERGY GY STAR® compliant co PC featuring a hard d	TAR® Logo STAR® sp onfiguration	iant product if offered within the mode o are compliant with the applicable U.S ecifications for computers. If a mode ons, then energy efficiency data listed is a high efficiency power supply, and a	
Heat Dissipation*	115VAC,	60Hz	230VAC, 50Hz		100VAC, 50Hz	
Normal Operation (Short idle)	14 BTU		14 BTU/hr		14 BTU/hr	
Normal Operation (Long idle)	2 BTU/	'hr	2 BTU/hr		2 BTU/hr	
Sleep	2 BTU/	hr	2 BTU/hr		2 BTU/hr	
Off	1 BTU/	'hr	1 BTU/hr		1 BTU/hr	
Declared Noise Emissions	attained for or	ound Power	calculated based on th	ne measur	Sound Pressure	
(in accordance with		(L <sub>wAd</sub> , bels)			(L <sub>pAm</sub> , decibels)	
ISO 7779 and ISO 9296)						
Typically Configured – Idle		2.6			14.3	
Fixed Disk – Random writes		2.7			14.3	
Optical Drive – Sequential reads	2.9				24.3	
Longevity and Upgrading  Additional Information	<ul> <li>This product can be upgraded, possibly extending its useful life by several years. Upgradeable features and/or components contained in the spare parts are available throughout the warranty period and or for up to "5" years after the end of production.</li> <li>This product is in compliance with the Restrictions of Hazardous Substances (RoHS) directive - 2011/65/EC.</li> <li>This HP product is designed to comply with the Waste Electrical and Electronic Equipment (WEEE) Directive - 2002/96/EC.</li> <li>This product is in compliance with California Proposition 65 (State of California; Safe Drinking Water and Toxic Enforcement Act of 1986).</li> <li>This product is in compliance with the IEEE 1680 (EPEAT) standard at the Gold level, see www.epeat.net</li> <li>Plastics parts weighing over 25 grams used in the product are marked per ISO11469 and ISO1043.</li> <li>This product is 12.98% recycle-able when properly disposed of at end of life.</li> </ul>					
	(WEEI  This prink  This prink  Www.  Plasti	E) Directive — product is in co ing Water and product is in co epeat.net ics parts weig 143.	2002/96/EC. ompliance with Califor I Toxic Enforcement Acompliance with the IEE hing over 25 grams us	nia Propos ct of 1986) EE 1680 (EF ed in the p	rition 65 (State of California; Safe PEAT) standard at the Gold level, see roduct are marked per ISO11469 and	
Packaging Materials	(WEEI  This prink  This prink  Www.  Plasti	E) Directive — product is in co ing Water and product is in co epeat.net ics parts weig 143.	2002/96/EC. compliance with Califor I Toxic Enforcement Ac compliance with the IEE hing over 25 grams us 98% recycle-able wher	nia Propos ct of 1986) E 1680 (EF ed in the p	rition 65 (State of California; Safe PEAT) standard at the Gold level, see roduct are marked per ISO11469 and	
Packaging Materials	(WEEI  This p Drinki  This p www.  Plasti ISO10	E) Directive — product is in co- ing Water and product is in co- epeat.net cs parts weig 143. product is 12.9	2002/96/EC. compliance with Califor I Toxic Enforcement Ac compliance with the IEE hing over 25 grams us 98% recycle-able wher	nia Propos ct of 1986) E 1680 (EF ed in the p	rition 65 (State of California; Safe PEAT) standard at the Gold level, see roduct are marked per ISO11469 and disposed of at end of life.	
Packaging Materials	(WEEI  This p Drinki This p www. Plasti ISO10 This p	E) Directive — product is in co- product is in co- product is in co- epeat.net posts weight product is 12.9  PAPER/Corru  PLASTIC/EPE	2002/96/EC. compliance with Califor I Toxic Enforcement Ac compliance with the IEE hing over 25 grams us 98% recycle-able wher	nia Propos ct of 1986) EE 1680 (EF ed in the p n properly	rition 65 (State of California; Safe PEAT) standard at the Gold level, see roduct are marked per ISO11469 and disposed of at end of life.	



### Technical Specifications

	The plastic packaging material contains at least 0% recycled content.		
	The corrugated paper packaging materials contains at least 57.8% recycled content.		
RoHS Compliance	HP Inc. complies fully with materials regulations. We were among the first companies to extend the restrictions in the European Union (EU) Restriction of Hazardous Substances (RoHS) Directive to our products worldwide through the HP GSE. HP has contributed to the development of related legislation in Europe, as well as China, India, and Vietnam.  We believe the RoHS directive and similar laws play an important role in promoting industry-wide elimination of substances of concern. We have supported the inclusion of additional substances—including PVC, BFRs, and certain phthalates—in future RoHS legislation that pertains to electrical and electronics products.  We met our voluntary objective to achieve worldwide compliance with the new EU RoHS requirements for virtually all relevant products by July 2013, and we will continue to extend the scope of the commitment to include further restricted substances as regulations continue to evolve.  To obtain a copy of the HP RoHS Compliance Statement, see HP RoHS position statement.		
Material Usage	This product does not contain any of the following substances in excess of regulatory limits (refer		
	to the HP General Specification for the Environment at http://www.hp.com/hpinfo/globalcitizenship/environment/supplychain/gen_specifications.html):  Asbestos Certain Azo Colorants Certain Brominated Flame Retardants – may not be used as flame retardants in plastics Cadmium Chlorinated Hydrocarbons Chlorinated Paraffins Bis(2-Ethylhexyl) phthalate (DEHP) Benzyl butyl phthalate (BBP) Dibutyl phthalate (DBP) Diisobutyl phthalate (DIBP) Formaldehyde Halogenated Diphenyl Methanes Lead carbonates and sulfates Lead and Lead compounds Mercuric Oxide Batteries Nickel – finishes must not be used on the external surface designed to be frequently handled or carried by the user. Ozone Depleting Substances Polybrominated Biphenyls (PBBs) Polybrominated Biphenyl Ethers (PBBEs) Polybrominated Biphenyl (PCB) Polychlorinated Biphenyl (PCB) Polychlorinated Terphenyls (PCT) Polyvinyl Chloride (PVC) – except for wires and cables, and certain retail packaging has been voluntarily removed from most applications. Radioactive Substances Tributyl Tin (TBT), Triphenyl Tin (TPT), Tributyl Tin Oxide (TBTO)		



## Technical Specifications

Packaging Usage	<ul> <li>HP follows these guidelines to decrease the environmental impact of product packaging:</li> <li>Eliminate the use of heavy metals such as lead, chromium, mercury and cadmium in packaging materials.</li> <li>Eliminate the use of ozone-depleting substances (ODS) in packaging materials.</li> <li>Design packaging materials for ease of disassembly.</li> <li>Maximize the use of post-consumer recycled content materials in packaging materials.</li> <li>Use readily recyclable packaging materials such as paper and corrugated materials.</li> <li>Reduce size and weight of packages to improve transportation fuel efficiency.</li> </ul>
	Plastic packaging materials are marked according to ISO 11469 and DIN 6120 standards.
End-of-life Management	HP offers end-of-life HP product return and recycling programs in many geographic areas. To recycle
and Recycling	your product, please go to: <a href="http://www.hp.com/go/reuse-recycle">http://www.hp.com/go/reuse-recycle</a> or contact your nearest HP sales office. Products returned to HP will be recycled, recovered or disposed of in a responsible manner.
	The EU WEEE directive (2002/95/EC) requires manufacturers to provide treatment information for each product type for use by treatment facilities. This information (product disassembly instructions) is posted on the Hewlett Packard web site at: <a href="http://www.hp.com/go/recyclers">http://www.hp.com/go/recyclers</a> . These instructions may be used by recyclers and other WEEE treatment facilities as well as HP OEM customers who integrate and re-sell HP equipment.
HP, Inc. Corporate	For more information about HP's commitment to the environment:
Environmental	Global Citizenship Report
Information	http://www.hp.com/hpinfo/globalcitizenship/gcreport/index.html Eco-label certifications
	http://www8.hp.com/us/en/hp-information/environment/ecolabels.html ISO 14001 certificates:
	http://h20195.www2.hp.com/V2/GetDocument.aspx?docname=c04755842 and
	http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/cert.pdf
footnotes	<ul> <li>Percentage of ocean-bound plastic contained in each component varies by product</li> <li>Recycled plastic content percentage is based on the definition set in the IEEE 1680.1-2018 standard.</li> <li>External power supplies, WWAN modules, power cords, cables and peripherals excluded.</li> <li>100% outer box packaging and corrugated cushions made from sustainably sourced certified and recycled fibers.</li> <li>Fiber cushions made from 100% recycled wood fiber and organic materials.</li> </ul>
	Plastic cushions are made from >90% recycled plastic.

### **COUNTRY OF ORIGIN**

China



Summary	of Changes	
Category	Description	Part Number
Cases	HP Prelude Pro Recycle Backpack	1X644AA
	HP Prelude Pro Recycle Top Load	1X645AA
	HP Business 14.1 Sleeve	2UW01AA
	HP Business 17.3 Backpack	2SC67AA
	HP Business 15.6 Top Load	2SC66AA
	HP Business Slim 14.1 Top Load	2SC65AA
	HP Business Slim 17.3 Top Load	2UW02AA
	HP Executive 14.1 Tote	6KD10AA
	HP Executive 15.6 Backpack	6KD07AA
	HP Executive 15.6 Top Load	6KD06AA
	HP Executive 17.3 Backpack	6KD05AA
	HP Executive 17.3 Top Load	6KD08AA
	HP Executive Convertible 14.1 Tote	5KN27AA
	HP Executive Leather 15.6 Top Load	6KD09AA
	HP Executive Slim 14.1 Top Load	6KD04AA
	HP Prelude G2 15.6 Backpack	1E7D6AA
	HP Prelude G2 15.6 Top Load	1E7D7AA
	HP Renew 14 Laptop Sleeve	2E6U9AA
	HP Renew Business 14.1 Laptop Bag	3E5F9AA
	HP Renew Business 14.1 Laptop Sleeve	3E2U7AA
	HP Renew Business 15.6 Laptop Bag	3E5F8AA
	HP Renew Business 17.3 Laptop Backpack	3E2U5AA
	HP Renew Business 17.3 Laptop Bag	3E2U6AA
Docking	HP Thunderbolt 120W Dock G2	2UK37AA
	HP Thunderbolt 120W Dock w/Audio G2	3YE87AA
	HP Thunderbolt 230W Dock w/Combo Cable G2	3TR87AA
	HP USB-C 120W G5 Dock	5TW10AA
	HP USB-C Mini Dock	1PM64AA
	HP USB-C/A 120W Universal Dock G2	5TW13AA
	HP USB-C Travel Dock G2	7PJ38AA
	HP Wired Thunderbolt Audio Module	3AQ21AA
	HP USB-C Travel Dock	4WX89AA
Input/Output	HP USB-C to HDMI 2.0 Adapter	2PC54AA#ABB
	HP USB-C to RJ45 Adapter	V8Y76AA#ABB,
	HP USB-C to USB 3.0 Adapter	V7W66AA N2Z63AA
	HP 320M Wired Mouse - New AMO	9VA80AA
	HP Travel Bluetooth Mouse - New AMO	6SP30AA
	HP Travel USB Mouse - New AMO	G1K28AA
	HP Wireless (Link-5) Keyboard	T6U20AA
	HP Slim Wireless Keyboard and Mouse	T6L04AA
	,	



Summary	of (	Chan	qes

	UI CHAITYES  UD Wireless USB Dramium Kouhaard	Z9N41AA
	HP Wireless USB Premium Keyboard	3M165AA
	HP Wireless Rechargeable 950MK Mouse and Keyboard	9SR36AA
	HP Wired Desktop 320MK Mouse and Keyboard	1Y4D0AA
	HP 235 WL Mouse and Keyboard Combo	
	HP 125 Wired Keyboard	266C9AA
	HP 225 Wired Mouse and Keyboard Combo	286J4AA
	HP HDMI to VGA Adapter	H4F02AA
	HP 125 USB-A Wired Mouse	265A9AA
	HP 128 USB Laser Wired Mouse	265D9AA
	HP 435 Bluetooth 5.0 + Wireless 2.4GHz Multi-Device Wireless Mouse	3B4Q5AA
	HP Creator USB-A+Bluetooth 935 Wireless Mouse	1D0K8AA
	HP USB-A+Bluetooth Multi-Device 635 Wireless Mouse Black	1D0K2AA
Audio/Video	HP 3.5mm G2 Stereo Headset	428K7AA
	HP USB G2 Stereo Headset	428K6AA
Power	HP 45W 4.5 mm LC Smart Japan Only AC Power Adapter	L6F60AA#ABJ
	HP 45W 4.5 mm Smart AC Power Adapter	H6Y88AA#ABA
	HP 45W USB-C LC AC Power Adapter	1MZ01AA#ABA
	HP 65W 4.5 mm Smart AC Power Adapter	H6Y89AA#ABA
	HP 65W 4.5 mm wDongle 7.4 mm Slim AC Power Adapter	H6Y82AA#ABA
	HP 65W USB-C LC AC Power Adapter	1P3K6AA#ABA
	HP 65W USB-C Slim Travel AC Power Adapter	X7W50AA#ABA
	HP 65W USB-C Auto AC Power Adapter	5TQ76AA
Power Bank	HP USB-C Essential Power Bank	3TB55AA
Storage	HP USB DVD-Writer EXT ODD	Y3T76AA
Memory	HP 4GB DDR4 3200 Memory	286H5AA
	HP 8GB DDR4 3200 Memory	286H8AA
	HP 16GB DDR4 3200 Memory	286J1AA
Security	HP Nano Cable Lock	1AJ39AA
	HP SureKey Standard/Nano/Wedge Cable Lock	6UW42AA
	HP Nano Master Keyed Cable Lock HP Notebook 14.0" Privacy Filter	1AJ40AA J6E65AA
UCC	HP Stereo 3.5mm Headset	T1A66AA
	HP Wired USB-A Stereo Headset	T1A67AA



### **Summary of Changes**

Date of change:	Version History:	Updated	Description of change:
February 2, 2021	V1 to V2	Update	Battery Life
February 9, 2021	V2 to V3	Add	Environmental Data
February 16, 2021	V3 to V4	Update	Wireless Section
February 18, 2021	V4 to V5	Update	Networking and Environmental Section
February 25, 2021	V5 to V6	Update	Xerox DocuShare offer value
April 20, 2021	V6 to V7	Updated	Memory Section and Input/ Output Section Updated
May 6, 2021	V7 to V8	Add	HP Smart Support
May 14, 2021	V8 to V9	Add	AMDR5 Pro/R7 Pro Processors
May 25, 2021	V9 to V10	Update	Micro SD Card Reader
June 11, 2021	V10 to V11	Remove	HP WorkWell from Software and Security section
July 15, 2021	V11 to V12	Update	At a Glance section and Networking WLAN section
July 30, 2021	V12 to V13	Update	At a Glance section, added HP Wolf Pro, Display and Accessories
August 13, 2021	V13 to V14	Add	WLAN in Networking/Communications section
September 10, 2021	V14 to V15	Add	WiFi 6E footnote in Networking section
October 22, 2021	V15 to V16	Update	Windows 10 with Free upgrade to Windows 11 when available in OS section and footnote
December 8, 2021	V16 to V17	Update	OS footnotes and callouts in Overall section
December 9, 2021	V17 to V18	Update	Wi-Fi 6 and Wi-Fi 6E footnotes
December 14, 2021	V18 to V19	Update	Windows OS section

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